

27th IEEE Symposium On Fusion Engineering Shanghai Marriott Hotel City Centre, 7th June 2017

Overview of the HCPB Research Activities in EUROfusion

Francisco. A. Hernández

Working Package HCPB Leader – Karlsruhe Institute of Technology, KIT

SCCFE Cierrot C CO ENEN IPP SKIT WIGHER

with contributions from

F. Arbeiter, L. V. Boccaccini, E. Bubelis, V. Chakin, I. Cristescu, B.-E. Ghidersa, W. Hering, X. Z. Jin, M. Kamlah, R. Knitter, M. H. H. Kolb, P. Kurinskiy, O. Leys, I. A. Maione, M. Moscardini, H. Neuberger, P. Pereslavtsev, S. Pupeschi, R. Rolli, S. Ruck, G. A. Spagnuolo, P. Vladimirov, C. Zeile, G. Zhou *(KIT)*, M. González and T. Hernández *(CIEMAT)*, B. Kiss *(BUTE)*, G. Nádasi *(WIGNER)*



Breeding Blanket Project



This work has been carried out within the framework of the EUROfusion Consortium and has received funding from the European Union's Horizon 2020 research and innovation programme under grant agreement number 633053. The views and opinions expressed herein do not necessarily reflect those of the European Commission.

Overview



- 1 Introduction
- 2 THE EU-DEMO HCPB: description
- 3 Design & analyses activities
- 4 R&D on functional materials
- 5 R&D in manufacturing and testing
- 6 R&D in FW heat transfer augmentation
- 7 HCPB key interfaces activities
- 8 Systems integration activities
- 9 Summary, challenges and future R&D plans



Introduction



- The EUROfusion's Breeding Blanket (BB) Project
 - WP1-HCPB W
- WP2-HCLL
 - 1. Concept definition and description
 - 2. Design & Analyses
 - 3. R&D functional materials
- Need for a holistic conceptual design!

WP3-WCLL

- WP4-DCLL
- a. R&D Manufacturing & testing
- b. R&D FW heat transfer augmentation
- c. Systems integration activities
- d. Key interfaces activities: BoP, Safety and TER





HCPB Design Description



Reference HCPB BL2015 V4

• EU DEMO1 Tokamak baseline 2015



HCPB Design Description







HCPB Design & Analysis Activities



Design cycle of the DEMO HCPB BB:

Preliminary conceptual design

- 1. Thermomechanics (TM) under in-box LOCA
- 2. Neutronics
- 3. Thermohydraulics (TH)
- 4. TM normal/off-normal (disruptions) operation

Preliminary conceptual design

- Sequencial design cycle:
 - Difficulty to conciliate many aspects in each step: safety, manufacturing feasibility, nuclear + TH + TM, materials and costs
- Neutronics+TH+TM coupling studies
- Pebble beds thermomechanics: DEM







R&D Functional Materials: Ceramic Breeders

- Reference EU CB: Li₄SiO₄
- "Advanced CB": Li₄SiO₄ + additions of Li₂TiO₃
 - From eutectic (25mol% Li₂TiO₃), Li₂TiO₃ dominates
 - Li-Density I, TBRI, crush load 11
- Production of Advanced Ceramic breeders (CBs)
 - The KALOS (<u>KA</u>rlsruhe <u>L</u>ithium <u>O</u>rtho<u>S</u>ilicate) Process
 - Melt processing at 1350 ÷ 1400 °C
 - Droplet generation by jet decay
 - Pebble solidification by liquid nitrogen spray
 - Optical monitoring by high-speed camera and image processing
 - > Mean pebble size 650 μm, adjustable
 - Batch process (ca. 1kg), but straightforward scale-up
- 2. Qualification of advanced CBs
 - Composition, recycling, activation, conductivity, stability
 - Characterization unirradiated: corrosion, steel compatibility

Design & Analysis Functonal Materials Manufacturing FW HT Augmentation HCPB Interfaces

Characterization irradiated: "T" (D) loading and release







R&D Functional Materials: Neutron Multiplier Materials (NMM)

- Reference EU NMM: Beryllium
- "Advanced Be-based NMM": Be₁₂Ti , Be₁₂Cr...
 - Reduced content of Be: lower swelling, less water-reactive, increased upper temperature limit, but lower T-breeding
- Production of Be NMM:
 - Reference EU: Rotating Electrode Method, REM (NGK, Japan)
 - Limited scalability to mass production, costly
 - Alternative cost-effective routes (under F&E contract):
 - Ball milling of Be-billets
 - Scrap from fluoride reduction method
- Development of beryllides (KIT + TU Berlin)
 - Rod by hot extrusion Be-Ti powder mixtures + REM
- 3. Characterization
 - Unirradiated pebbles: T-release, oxidation, interactions...
 - Irradiated NGK pebbles: HIDOBE 01 & 02, <6000apm, <750°C

HCPB Description Design & Analysis Functional Materials Manufacturing FW HT Augmentation HCPB Interfaces Systems Integration

Creep, swelling,T-release, retention, activation...







R&D Manufacturing and Testing



- Realization of key HCPB components:
 - Technology development and standardization
 - Mock-Ups (MU) qualification with codes & standards
 - Industrial contracts for long-term collaboration
- Main manufacturing and assembly routes:
 - Electrical Discharge Machining (EDM):
 - FW and CP cooling channels, with pilot hole
 - Cold forming for non-planar plates
 - E.g. ½ FW demonstrator: EDM + cold bending
 - Joining: Electron Beam welding
- Special manufacturing techniques
 - Selective Laser Syntering (SLS): complex parts
 - Hybrid assemblies: CNC + SLS + EB

Introduction

- FW artificial roughness (AR) with die sink EDM
- MU testing in He-loops (HELOKA, KATHELO)
 - Full-scale FW + sustained 1 MW/m² FW with AR

Design & Analysis Functional Materials



F. A. Hernández et al. | IEEE SOFE 2017 | Shanghai | 07/06/2017 | Page 10

Manufacturing FW HT Augmentation HCPB Interfaces

F. A. Hernández et al. | IEEE SOFE 2017 | Shanghai | 07/06/2017 | Page 11

Manufacturing FW HT Augmentation HCPB Interfaces

R&D FW Heat Transfer Augmentation

- Heat Transfer Augmentation by rib-roughening:
 - Motivation: HHF FW regions at upper and lower port
 - Ribs: HTC**1**, but for same cooling, flow rate reduced $P_{pump} \propto \dot{m}^3$
 - Ribbed channels sustaining HHF for same P_{pump}!
- E.g. recent design point studies:

8000

7000

6000

5000

4000

3000

2000

1000

Introduction

Ω

0

Heat transfer coefficient h^{*} , h^{*}_{1} [W/(m² K)]

- Squared channels of 12.5mm, 60 g/s channel (59 m/s)
- Transversal ribs (TSR), HTC = 9500 W/(m^{2} K), $\Delta p = 0.52$ bar/m

Design & Analysis Functional Materials



3.0



- Temps <550°C
- P stress \approx 72 MPa \odot
- P+Q stress ≈ 393 MPa ☺
- 1 MW/m² can be sustained in a FW with TSR-ribbed Hecooled channels
- UVR HTC performance 1.15x better than TSR!



Key HCPB Interfaces Activities: BoP



- Integration of the HCPB BB into the BoP
- Currently, 3 cooling circuits:
 - PHTS: HCPB BB
 - IHTS: Energy Storage System (ESS) with molten salt (similarly as in Concentrated Solar Power)
 - PCS: Rankine cycle, water as working fluid
- Definition of components & loops characteristics:
 - 3 IB + 6 OB loops, 2 circulators / loop
 - 1 IHX / loop coupling PHTS loops with to ESS
 - Steam Generator coupling ESS with PCS
 - PCS: "conventional", but with many heat sources
- Architecture of BoP
 - Credibility of a HCPB-DEMO depends on compatibility with state-of-the-art technology!
 - Some tech. extrapolation assumed for circulators: available 5-6MW, needed ≈8MW
 - $\eta_{th} \approx 36\%$, high $T_{He,out}$ advantage shadowed due to particular DEMO features (ESS)
 - Synergies at BB design level: get closer to AGRs, GenIV-HTRs values: T_{out} 1, P_{circ} 4, off-the-shelf tech.





F. A. Hernández et al. | IEEE SOFE 2017 | Shanghai | 07/06/2017 | Page 13

Manufacturing FW HT Augmentation **HCPB Interfaces** Systems Integration

Key HCPB Interfaces Activities: Safety

FFMEA->PIEs->critical events (within DBA)

- Loss of flow accident (LOFA) in FW
 - CFD model set-up for 1÷2 channels
 - RELAP5-3D for mitigating features (circuit / circulator redundancy, plasma shutdown)
 - Codes validation with LOFA experiment

HCPB Description Design & Analysis Functional Materials

- Deterministic LOCAs with MELCOR186:
 - In-box LOCA (1 CP break), in-vessel (FW channels break), integrated in 1 OB loop PHTS
- He OB inventory: 9.5 ton \Rightarrow
 - Combined VVPSS & EV concept, EV potentially reduced ≈80%
- Simulation of runaway e⁻ event
- Future work:

Introduction

- Analysis of ex-vessel LOCA
- Modelling of the HCPB BB integrated into ist PHTS and auxiliary systems of BoP using RELAP5-3D
- Synergies at BB design level: pipework upper port, study possibility to p_{He} (HTRs, 6-7MPa)



detailed 1x OB4 module



Systems Integration Activities



Development of a HCPB BB attachment

- Key interfacing component between VV and BB
- Attachment system
 - Defines segments kinematics (affects RM)
 - Affects segments internal stresses
- EM analyses of disruptions events -> input EM forces
- Analyses of full HCPB DEMO sectors with EM + thermal + gravity + coolant pressure loads
- Fueling lines integration:
 - Current baseline: 1 line between IB segments
 - Affected BB region: increased gap -> n streaming
 - Further work:

Introduction

- On cooling: passive or active
- > On fixation: VV or BB
- Thermohydraulics + thermomechanics

Design & Analysis Functional Materials



F. A. Hernández et al. | IEEE SOFE 2017 | Shanghai | 07/06/2017 | Page 14

Manufacturing FW HT Augmentation HCPB Interfaces Systems Integration

Summary, Challenges and Future Plans



- HCPB R&D focused on BB specifics + key interfaces driving the design
- HCPB development achievements (with respect to former concepts):
 - Design simplification: thermohydraulics, assembly and manufacturing, pipework
 - HCPB actively working with interfaces to propose mitigating actions for a credible holistic solution!
 - Advanced CBs: significant gains in strength, up-scalable production
 - Be: alternative, cost-effective production routes
- Challenges:
 - EU Roadmap: "pragmatic approach" -> Reliability and Availability -> Mature technologies preferred
 - High uncertainties in DEMO architecture -> resilient, flexible BB designs
 - FW HHF cooling without penalizing Δp
- Future design and R&D plans
 - Redefine HCPB concept to reach figures with gas-cooled reactors (HTRs/AGRs): P_{circ}, p_{He}, (T_{He,out})
 - Broadening palette of CB (for higher T breeding) and NMM (beryllides, Be alternatives)

